



# FFPF30UP20DP

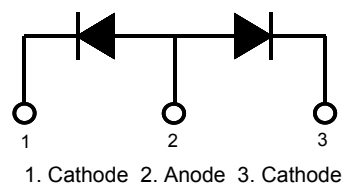
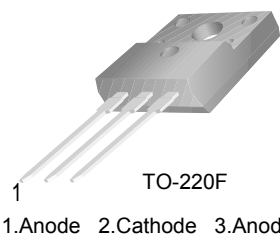
## Ultrafast Recovery Power Rectifier

### Features

- Ultrafast with Soft Recovery : < 45ns (@ $I_F = 15A$ )
- High Reverse Voltage :  $V_{RRM} = 200V$
- Avalanche Energy Rated
- Planar Construction

### Applications

- Output Rectifiers
- Switching Mode Power Supply
- Free-wheeling diode for motor application
- Power switching circuits



### Absolute Maximum Ratings (per diode) $T_C = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Peak Repetitive Reverse Voltage	200	V
$V_{RWM}$	Working Peak Reverse Voltage	200	V
$V_R$	DC Blocking Voltage	200	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 105^\circ C$	15	A
$I_{FSM}$	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	150	A
$T_J, T_{STG}$	Operating Junction and Storage Temperature	- 65 to +150	$^\circ C$

### Thermal Characteristics

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.8	$^\circ C/W$

### Package Marking and Ordering Information

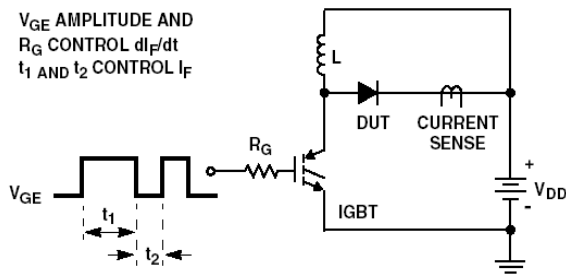
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F30UP20DP	FFPF30UP20DPTU	TO-220F	-	-	50

### Electrical Characteristics (per diode) $T_C = 25^\circ\text{C}$ unless otherwise noted

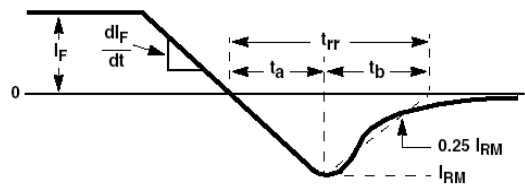
Symbol	Parameter	Min.	Typ.	Max.	Units	
$V_{FM}^*$	$I_F = 15\text{A}$ $I_F = 15\text{A}$	$T_C = 25^\circ\text{C}$	-	-	1.15	V
		$T_C = 100^\circ\text{C}$	-	-	1.0	V
$I_{RM}^*$	$V_R = 200\text{V}$ $V_R = 200\text{V}$	$T_C = 25^\circ\text{C}$	-	-	100	$\mu\text{A}$
		$T_C = 100^\circ\text{C}$	-	-	500	$\mu\text{A}$
$t_{rr}$	$I_F = 1\text{A}, di/dt = 100\text{A}/\mu\text{s}, V_{CC} = 30\text{V}$ $I_F = 15\text{A}, di/dt = 200\text{A}/\mu\text{s}, V_{CC} = 130\text{V}$	$T_C = 25^\circ\text{C}$	-	-	35	ns
		$T_C = 25^\circ\text{C}$	-	-	45	ns
$t_a$ $t_b$ $Q_{rr}$	$I_F = 15\text{A}, di/dt = 200\text{A}/\mu\text{s}, V_{CC} = 130\text{V}$	$T_C = 25^\circ\text{C}$	-	13	-	ns
		$T_C = 25^\circ\text{C}$	-	11	-	ns
		$T_C = 25^\circ\text{C}$	-	24	-	nC
$W_{AVL}$	Avalanche Energy ( $L = 40\text{mH}$ )	20	-	-	mJ	

\* Pulse Test: Pulse Width=300 $\mu\text{s}$ , Duty Cycle=2%

### Test Circuit and Waveforms

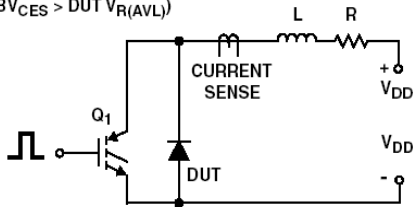


$t_{rr}$  TEST CIRCUIT

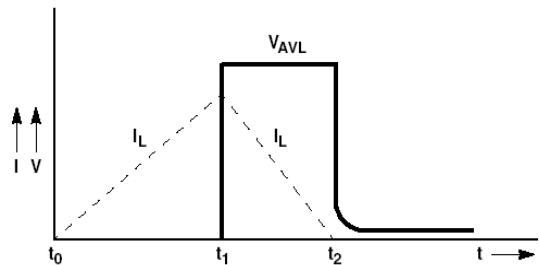


$t_{rr}$  WAVEFORMS AND DEFINITIONS

$I_{MAX} = 1\text{A}$   
 $L = 40\text{mH}$   
 $R < 0.1\Omega$   
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$   
 $Q_1 = \text{IGBT (}BV_{CES} > \text{DUT } V_{R(AVL)})$



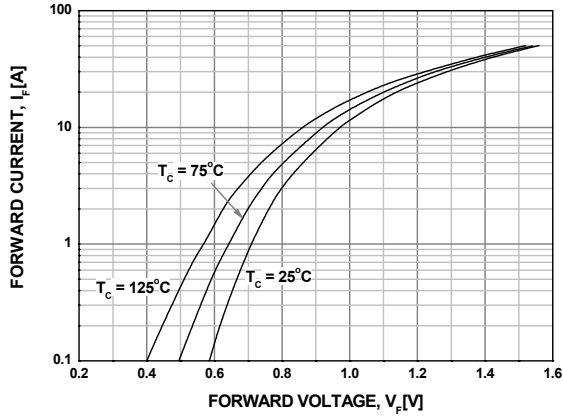
AVALANCHE ENERGY TEST CIRCUIT



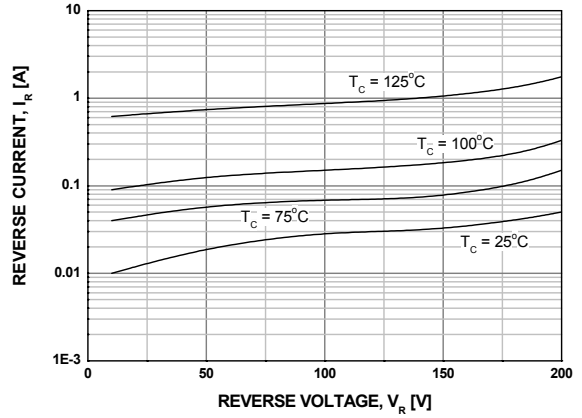
AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## Typical Performance Characteristics

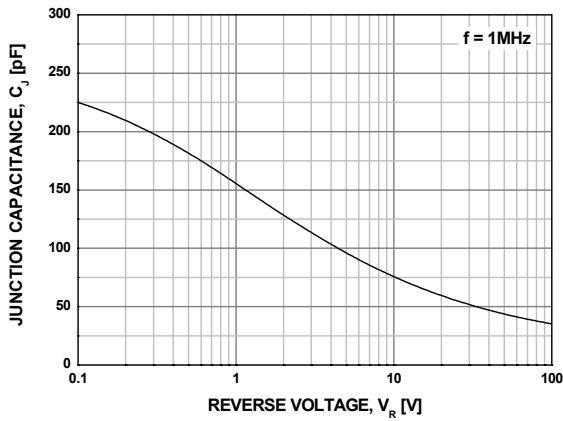
**Figure 1. Typical Forward Voltage Drop**



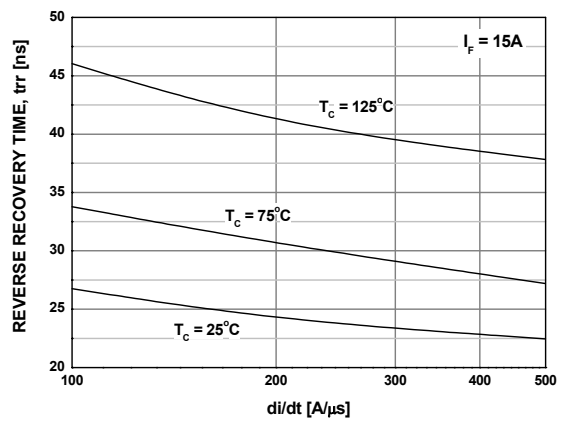
**Figure 2. Typical Reverse Current**



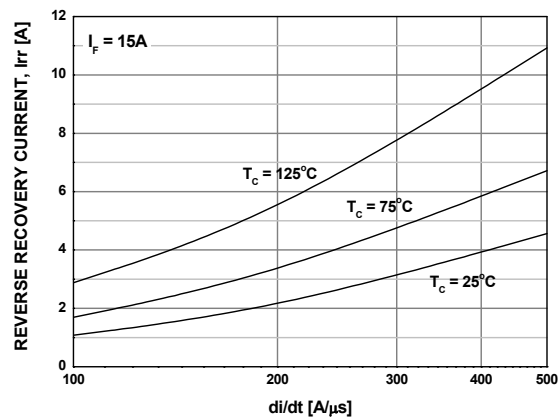
**Figure 3. Typical Junction Capacitance**



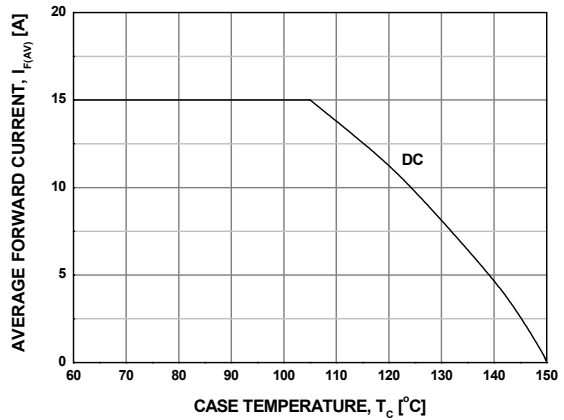
**Figure 4. Typical Reverse Recovery Time**



**Figure 5. Typical Reverse Recovery Current**

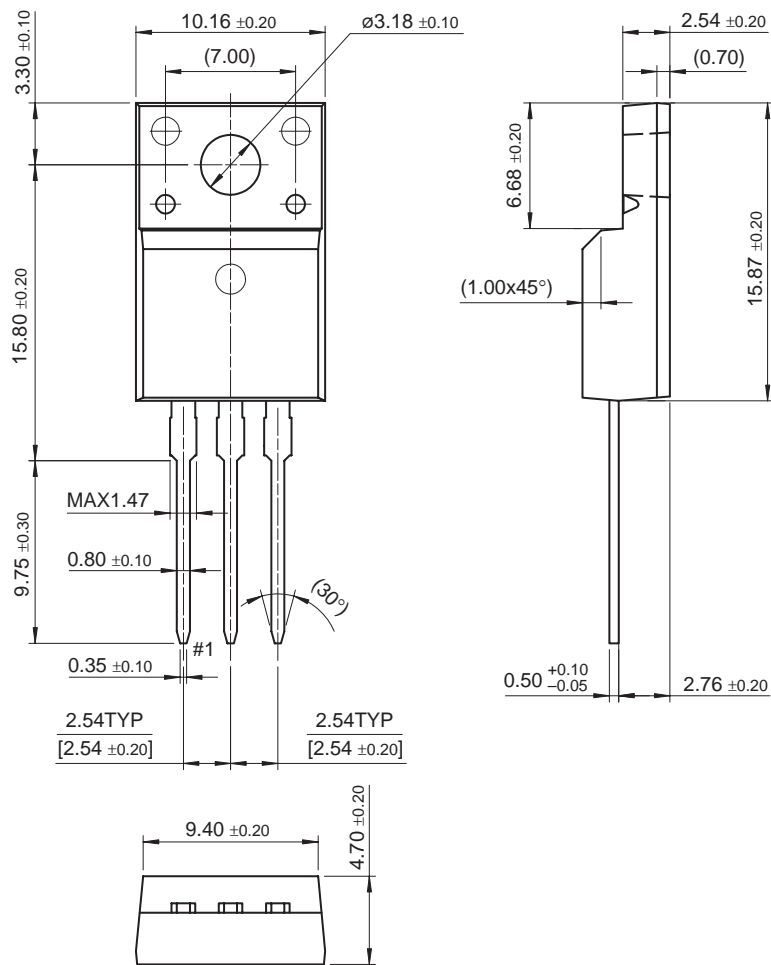


**Figure 6. Forward Current Deration Curve**



Package Demensions

TO-220F



Dimensions in Millimeters

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EcoSPARK™	I <sup>2</sup> C™	MSXPro™	RapidConnect™	UHC™
E <sup>2</sup> CMOS™	i-Lo™	OCX™	μSerDes™	UltraFET®
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FACT Quiet Series™		OPTOPLANAR™	SMART START™	Wire™
		PACMAN™	SPM™	
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